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Stocking Distributor

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[ON Semiconductor](#)  
[BFR30LT1](#)

For any questions, you can email us directly:

[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)

# BFR30LT1, BFR31LT1

## JFET Amplifiers

### N-Channel

#### Features

- Pb-Free Package is Available

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	25	Vdc
Gate-Source Voltage	$V_{GS}$	25	Vdc

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

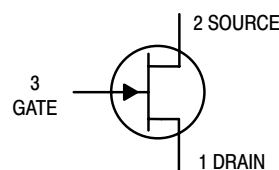
Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 1) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	225 1.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Total Device Dissipation Alumina Substrate, (Note 2) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	300 2.4	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

- Device mounted on FR4 glass epoxy printed circuit board using the recommended footprint.
- Alumina =  $0.4 \times 0.3 \times 0.024$  in 99.5% alumina.

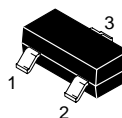


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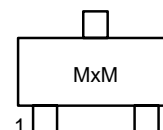
<http://onsemi.com>



#### MARKING DIAGRAM



SOT-23  
CASE 318  
STYLE 10



x = 1 or 2  
M = Date Code

#### ORDERING INFORMATION

Device	Package	Shipping†
BFR30LT1	SOT-23	3000/Tape & Reel
BFR30LT1G	SOT-23 (Pb-Free)	3000/Tape & Reel
BFR31LT1	SOT-23	3000/Tape & Reel
BFR31LT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### BFR30LT1, BFR31LT1

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Gate Reverse Current ( $V_{GS} = 10\text{ Vdc}, V_{DS} = 0$ )	$I_{GSS}$	-	0.2	nAdc
Gate Source Cutoff Voltage ( $I_D = 0.5\text{ nAdc}, V_{DS} = 10\text{ Vdc}$ )	$V_{GS(OFF)}$	-	5.0	Vdc
		-	2.5	
Gate Source Voltage ( $I_D = 1.0\text{ mAdc}, V_{DS} = 10\text{ Vdc}$ )	$V_{GS}$	-0.7	-3.0	Vdc
		-	-1.3	
$(I_D = 50\text{ }\mu\text{Adc}, V_{DS} = 10\text{ Vdc})$		-	-4.0	
		-	-2.0	

**ON CHARACTERISTICS**

Zero-Gate-Voltage Drain Current ( $V_{DS} = 10\text{ Vdc}, V_{GS} = 0$ )	BFR30 BFR31	$I_{DSS}$	4.0 1.0	10 5.0	mAdc
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**SMALL-SIGNAL CHARACTERISTICS**

Forward Transconductance ( $I_D = 1.0\text{ mAdc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ kHz}$ )  ( $I_D = 200\text{ }\mu\text{Adc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ kHz}$ )	BFR30 BFR31 BFR30 BFR31	$ Y_{fs} $	1.0 1.5 0.5 0.75	4.0 4.5 - -	mmhos
Output Admittance ( $I_D = 1.0\text{ mAdc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ kHz}$ ) ( $I_D = 200\text{ }\mu\text{Adc}, V_{DS} = 10\text{ Vdc}$ )	BFR30 BFR31	$ Y_{os} $	40 20	25 15	$\mu\text{mhos}$
Input Capacitance ( $I_D = 1.0\text{ mAdc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ MHz}$ ) ( $I_D = 200\text{ }\mu\text{Adc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ MHz}$ )		$C_{iss}$	- -	5.0 4.0	pF
Reverse Transfer Capacitance ( $I_D = 1.0\text{ mAdc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ MHz}$ ) ( $I_D = 200\text{ }\mu\text{Adc}, V_{DS} = 10\text{ Vdc}, f = 1.0\text{ MHz}$ )		$C_{rss}$	- -	1.5 1.5	pF

**TYPICAL CHARACTERISTICS**

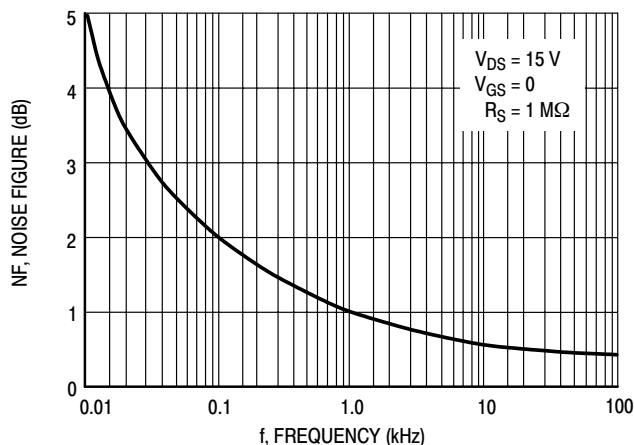


Figure 1. Noise Figure versus Frequency

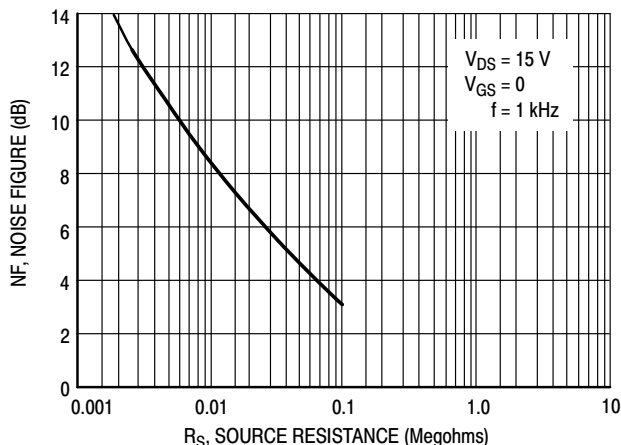


Figure 2. Noise Figure versus Source Resistance

## BFR30LT1, BFR31LT1

### TYPICAL CHARACTERISTICS

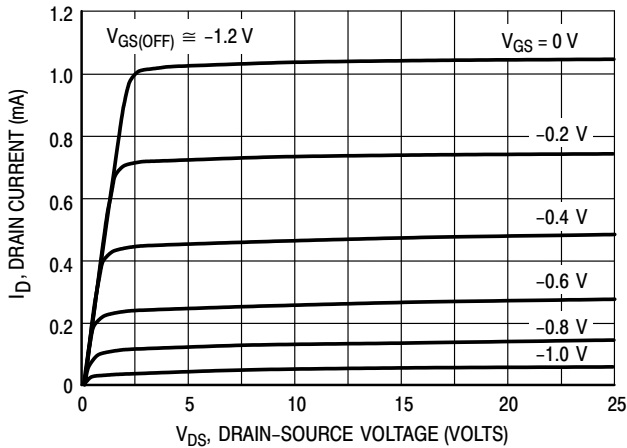


Figure 3. Typical Drain Characteristics

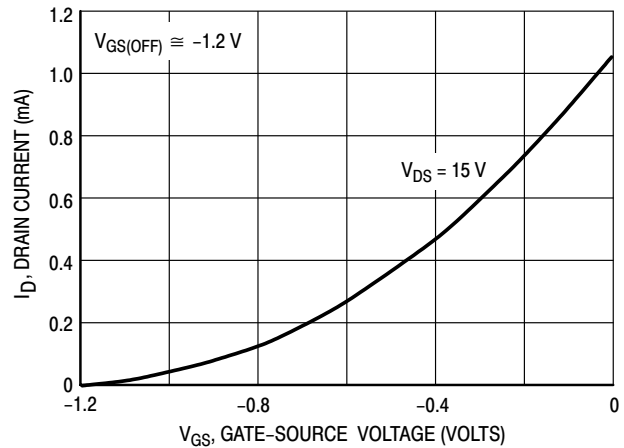


Figure 4. Common Source Transfer Characteristics

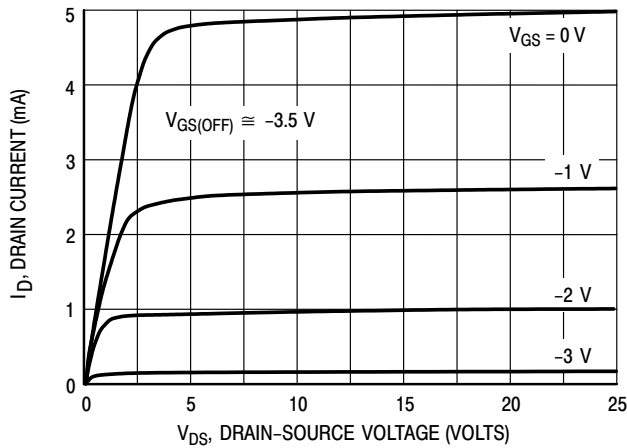


Figure 5. Typical Drain Characteristics

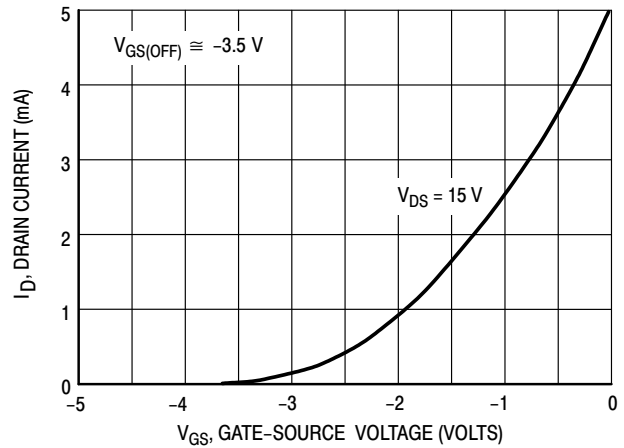


Figure 6. Common Source Transfer Characteristics

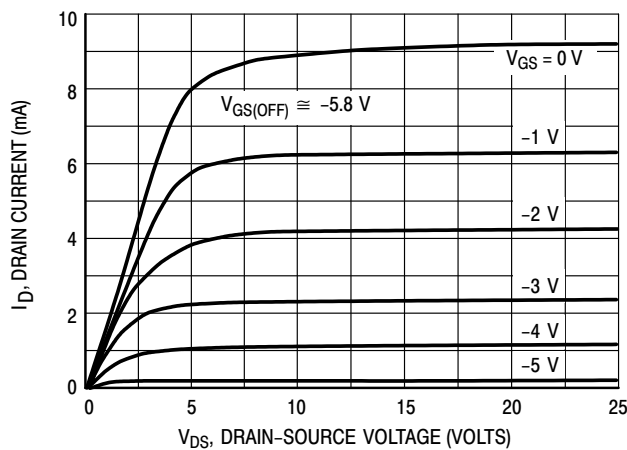


Figure 7. Typical Drain Characteristics

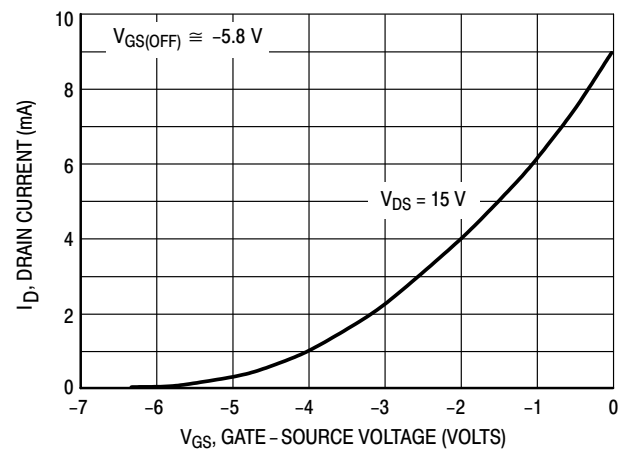


Figure 8. Common Source Transfer Characteristics

Note: Graphical data is presented for dc conditions. Tabular data is given for pulsed conditions (Pulse Width = 630 ms, Duty Cycle = 10%). Under dc conditions, self heating in higher  $I_{DSS}$  units reduces  $I_{DSS}$ .

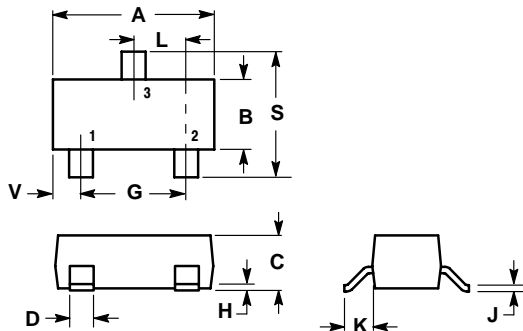
## BFR30LT1, BFR31LT1

### PACKAGE DIMENSIONS

#### SOT-23 (TO-236)

CASE 318-08

ISSUE AK



NOTES:

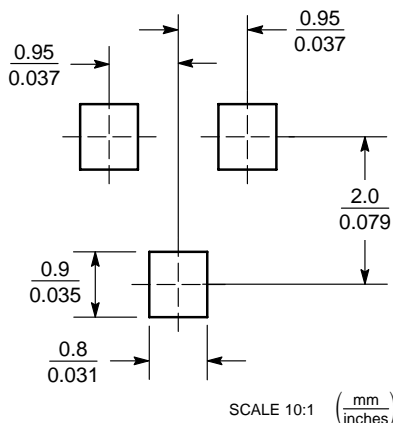
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60


STYLE 10:

- PIN 1. DRAIN
2. SOURCE
3. GATE

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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